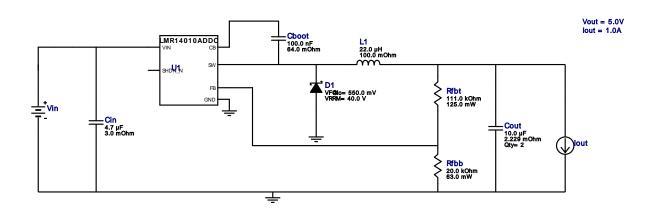


WEBENCH® Design Report

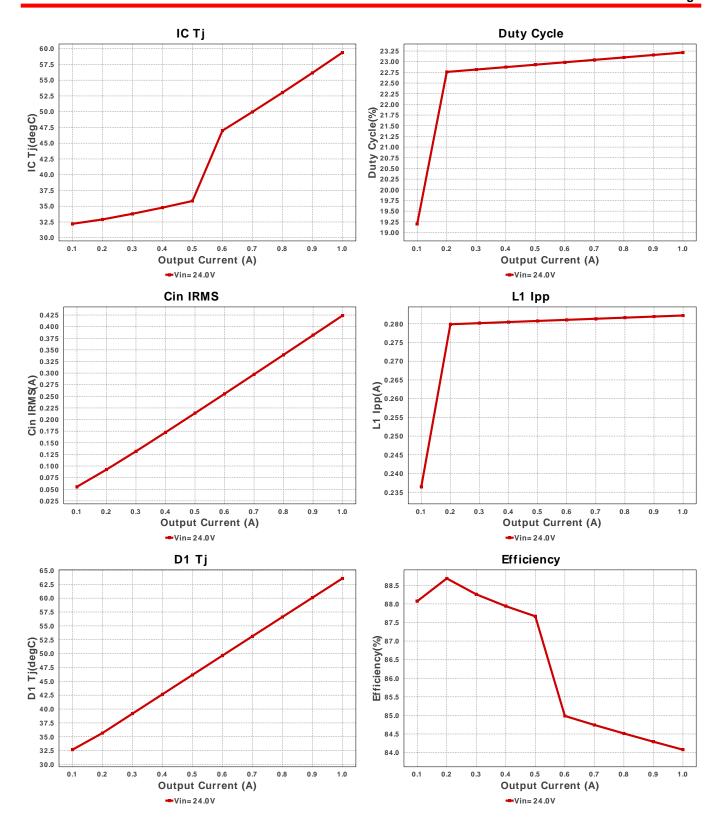
VinMin = 24.0V VinMax = 24.0V Vout = 5.0V Iout = 1.0A Device = LMR14010ADDCR Topology = Buck Created = 2021-02-22 22:31:40.625 BOM Cost = \$1.29 BOM Count = 9 Total Pd = 0.95W

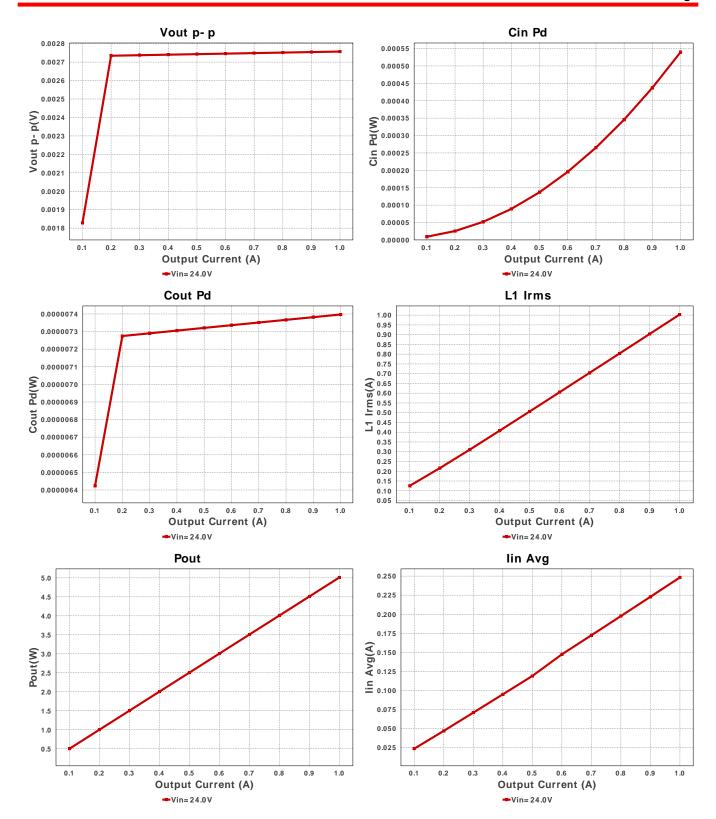
Design: 4 LMR14010ADDCR LMR14010ADDCR 24V-24V to 5.01V @ 1A

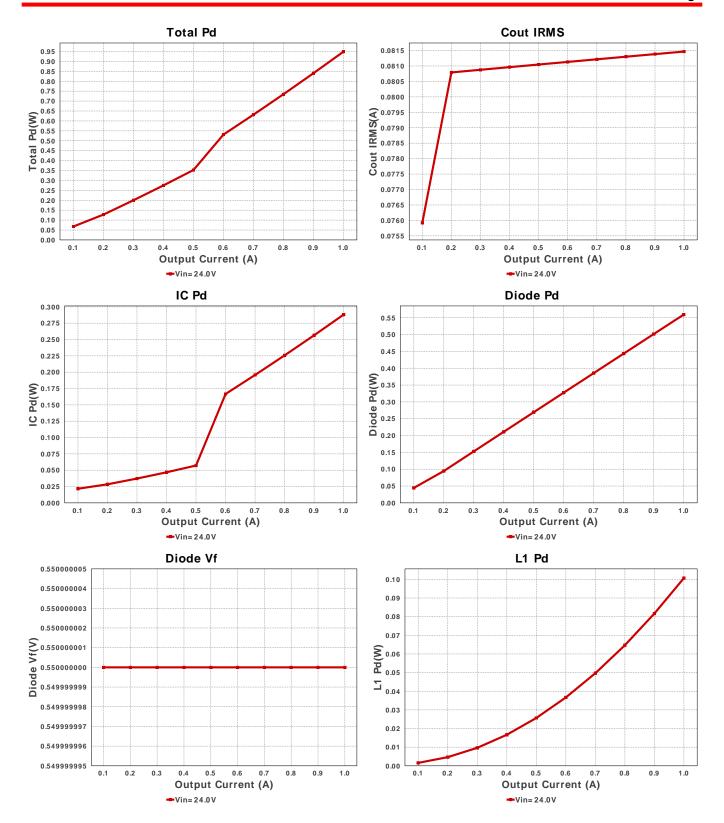


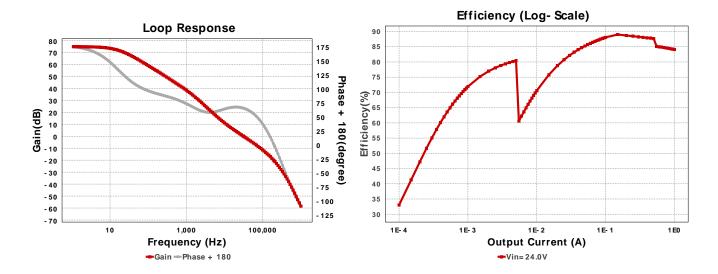
### **Electrical BOM**

Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Cboot	Kemet	C0805C104M5RACTU Series= X7R	Cap= 100.0 nF ESR= 64.0 mOhm VDC= 50.0 V IRMS= 1.64 A	1	\$0.01	0805 7 mm <sup>2</sup>
Cin	MuRata	GRM31CR71H475KA12L Series= X7R	Cap= 4.7 uF ESR= 3.0 mOhm VDC= 50.0 V IRMS= 4.98 A	1	\$0.22	1206 11 mm <sup>2</sup>
Cout	TDK	C3216X6S1V106K160AC Series= X6S	Cap= 10.0 uF ESR= 2.229 mOhm VDC= 35.0 V IRMS= 4.8593 A	2	\$0.18	1206_180 11 mm <sup>2</sup>
D1	Fairchild Semiconductor	SS24FL	VF@Io= 550.0 mV VRRM= 40.0 V	1	\$0.05	SOD-123F 12 mm <sup>2</sup>
L1	NIC Components	NPI105C220MTRF	L= 22.0 μH 100.0 mOhm	1	\$0.18	IND_NPI105C 141 mm²
Rfbb	Vishay-Dale	CRCW040220K0FKED Series= CRCWe3	Res= 20.0 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm <sup>2</sup>
Rfbt	Yageo	RT0805BRD07111KL Series= RT0805	Res= 111.0 kOhm Power= 125.0 mW Tolerance= 0.1%	1	\$0.06	0805 7 mm <sup>2</sup>
U1	Texas Instruments	LMR14010ADDCR	Switcher	1	\$0.40	DDC0006A_N 10 mm <sup>2</sup>









## **Operating Values**

#	Name	Value	Category	Description
1.	Cin IRMS	424.023 mA	Capacitor	Input capacitor RMS ripple current
2.	Cin Pd	539.39 μW	Capacitor	Input capacitor power dissipation
3.	Cout IRMS	81.467 mA	Capacitor	Output capacitor RMS ripple current
4.	Cout Pd	7.397 µW	Capacitor	Output capacitor power dissipation
5.	D1 Tj	63.56 degC	Diode	D1 junction temperature
6.	Diode Pd	559.33 mW	Diode	Diode power dissipation
7.	Diode Vf	550.0 mV	Diode	Forward voltage drop of diode D1
8.	IC Pd	288.09 mW	IC	IC power dissipation
9.	IC Tj	59.385 degC	IC	IC junction temperature
10.	IC Tolerance	18.0 mV	IC	IC Feedback Tolerance
11.	ICThetaJA	102.0 degC/W	IC	IC junction-to-ambient thermal resistance
12.	lin Avg	248.28 mA	IC	Average input current
	L1 Irms	1.003 A	Inductor	Inductor ripple current
	L1 Pd	100.66 mW	Inductor	Inductor power dissipation
	Cin Pd	539.39 μW	Power	Input capacitor power dissipation
	Cout Pd	7.397 µW	Power	Output capacitor power dissipation
17.	Diode Pd	559.33 mW	Power	Diode power dissipation
	IC Pd	288.09 mW	Power	IC power dissipation
	L1 Pd	100.66 mW	Power	Inductor power dissipation
20.	Total Pd	948.807 mW	Power	Total Power Dissipation
	BOM Count	946.607 11100		•
21.	BOIVI Count	9	System	Total Design BOM count
00	C	04 447 1.11-	Information	Dada alat assassina francisco
22.	Cross Freq	31.447 kHz	System	Bode plot crossover frequency
			Information	
23.	Duty Cycle	23.215 %	System	Duty cycle
			Information	
24.	Efficiency	84.077 %	System	Steady state efficiency
			Information	
25.	FootPrint	213.0 mm <sup>2</sup>	System	Total Foot Print Area of BOM components
			Information	
26.	Frequency	700.0 kHz	System	Switching frequency
			Information	
27.	Gain Marg	-20.656 dB	System	Bode Plot Gain Margin
			Information	
28.	lout	1.0 A	System	lout operating point
			Information	
29.	L1 lpp	282.211 mA	System	
		-	Information	
30.	Low Freq Gain	74.822 dB	System	Gain at 1Hz
00.	Low Froq Cam	T HOLL GD	Information	Jan at 1112
31.	Mode	CCM	System	Conduction Mode
51.	Mode	OOW	Information	Conduction Wood
32.	Phase Marg	66.506 deg	System	Bode Plot Phase Margin
32.	Fliase ivialy	66.506 deg	•	Bode Flot Friase Margin
00	Devet	5.04.10/	Information	Total autout a succe
33.	Pout	5.01 W	System	Total output power
0.4	Tatal DOM	<b>#</b> 4.00	Information	Tetal BOM Ocea
34.	Total BOM	\$1.29	System	Total BOM Cost
			Information	
35.	Vin	24.0 V	System	Vin operating point
			Information	
36.	Vout	5.0 V	System	Operational Output Voltage
			Information	

#	Name	Value	Category	Description
37.	Vout Actual	5.011 V	System Information	Vout Actual calculated based on selected voltage divider resistors
38.	Vout Tolerance	3.317 %	System Information	Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable
39.	Vout p-p	2.758 mV	System Information	Peak-to-peak output ripple voltage

## **Design Inputs**

Name	Value	Description	
lout	1.0	Maximum Output Current	
VinMax	24.0	Maximum input voltage	
VinMin	24.0	Minimum input voltage	
Vout	5.0	Output Voltage	
base_pn	LMR14010A	Base Product Number	
source	DC	Input Source Type	
Та	30.0	Ambient temperature	

## WEBENCH® Assembly

#### Component Testing

Some published data on components in datasheets such as Capacitor ESR and Inductor DC resistance is based on conservative values that will guarantee that the components always exceed the specification. For design purposes it is usually better to work with typical values. Since this data is not always available it is a good practice to measure the Capacitance and ESR values of Cin and Cout, and the inductance and DC resistance of L1 before assembly of the board. Any large discrepancies in values should be electrically simulated in WEBENCH to check for instabilities and thermally simulated in WebTHERM to make sure critical temperatures are not exceeded.

#### Soldering Component to Board

If board assembly is done in house it is best to tack down one terminal of a component on the board then solder the other terminal. For surface mount parts with large tabs, such as the DPAK, the tab on the back of the package should be pre-tinned with solder, then tacked into place by one of the pins. To solder the tab town to the board place the iron down on the board while resting against the tab, heating both surfaces simultaneously. Apply light pressure to the top of the plastic case until the solder flows around the part and the part is flush with the PCB. If the solder is not flowing around the board you may need a higher wattage iron (generally 25W to 30W is enough).

#### Initial Startup of Circuit

It is best to initially power up the board by setting the input supply voltage to the lowest operating input voltage 24.0V and set the input supply's current limit to zero. With the input supply off connect up the input supply to Vin and GND. Connect a digital volt meter and a load if needed to set the minimum lout of the design from Vout and GND. Turn on the input supply and slowly turn up the current limit on the input supply. If the voltage starts to rise on the input supply continue increasing the input supply current limit while watching the output voltage. If the current increases on the input supply, but the voltage remains near zero, then there may be a short or a component misplaced on the board. Power down the board and visually inspect for solder bridges and recheck the diode and capacitor polarities. Once the power supply circuit is operational then more extensive testing may include full load testing, transient load and line tests to compare with simulation results.

#### Load Testing

The setup is the same as the initial startup, except that an additional digital voltmeter is connected between Vin and GND, a load is connected between Vout and GND and a current meter is connected in series between Vout and the load. The load must be able to handle at least rated output power + 50% (7.5 watts for this design). Ideally the load is supplied in the form of a variable load test unit. It can also be done in the form of suitably large power resistors. When using an oscilloscope to measure waveforms on the prototype board, the ground leads of the oscilloscope probes should be as short as possible and the area of the loop formed by the ground lead should be kept to a minimum. This will help reduce ground lead inductance and eliminate EMI noise that is not actually present in the circuit.

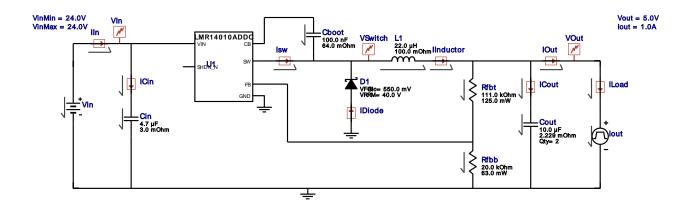


# **WEBENCH**<sup>®</sup> Electrical Simulation Report

Design Id = 4

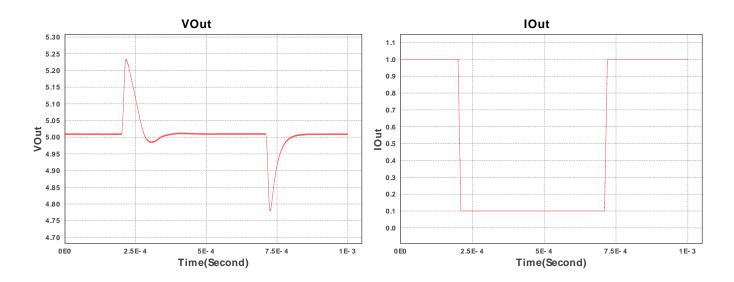
 $sim_id = 2$ 

Simulation Type = Load Transient



### Simulation Parameters

#	Name	Parameter Name	Description	Values
1.	Cboot	IC	Initial Voltage	7 V
2.	lout	signal_type	Signal Type	PULSE
		11	Initial Current	1.0 A
		12	Peak Current	0.1 A
		Td	Initial Delay Time	0.2m Sec
		Tr	Rise Time	10u Sec
		Tf	Fall Time	10u Sec
		Pw	Pulse Width	500u Sec



### Design Assistance

- 1. Master key: 9810EF8B6453D2AE[v1]
- 2. LMR14010A Product Folder: http://www.ti.com/product/LMR14010A: contains the data sheet and other resources.

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